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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Ilya Karpov et al.

Serial No.: 10/822,361

Filed: April 12, 2004

For: Fabricating Deeper and  
Shallower Trenches in  
Semiconductor Structures

§ Art Unit: 2814  
§  
§ Examiner: Long Pham  
§  
§ Docket: ITL.0835D1US  
§ P14730D  
§  
§ Assignee: Intel Corporation  
§  
§ Conf. No. 3077

Mail Stop **Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REPLY TO OFFICE ACTION**

Sir:

In response to the office action mailed March 21, 2007, please amend the above-referenced patent application as follows:

Date of Deposit: June 11, 2007  
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.  
*Cynthia L. Hayden*  
Cynthia L. Hayden